



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of

: **Confirmation No. 5528**

Etsuko NAKAMURA et al.

: Attorney Docket No. 2003\_1698A

Serial No. 10/721,164

: Group Art Unit 1752

Filed November 26, 2003

: Examiner Amanda C. Walke

LOWER LAYER MATERIAL FOR WIRING,  
EMBEDDED MATERIAL, AND  
WIRING FORMATION METHOD

**Mail Stop: Amendment**

---

**RESPONSE**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

This is in response to the Official Action dated September 7, 2005.